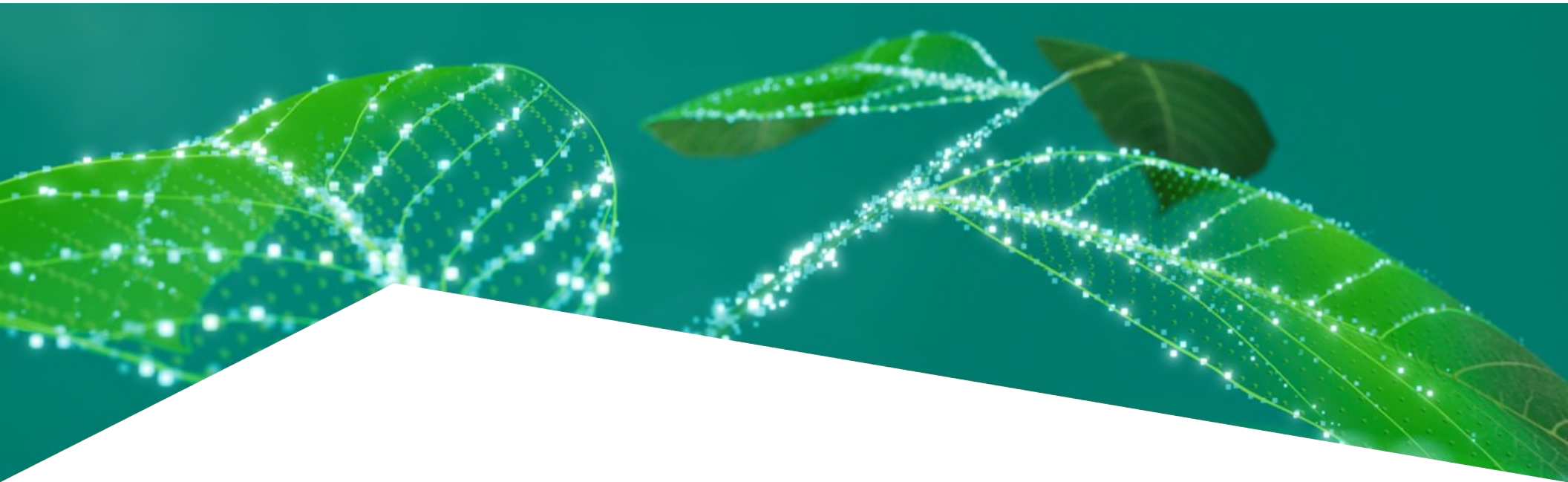




Exploring the benefits of the HSC topology in high performance AI power systems

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Infineon Technologies
November 7th 2025



Public

Table of contents

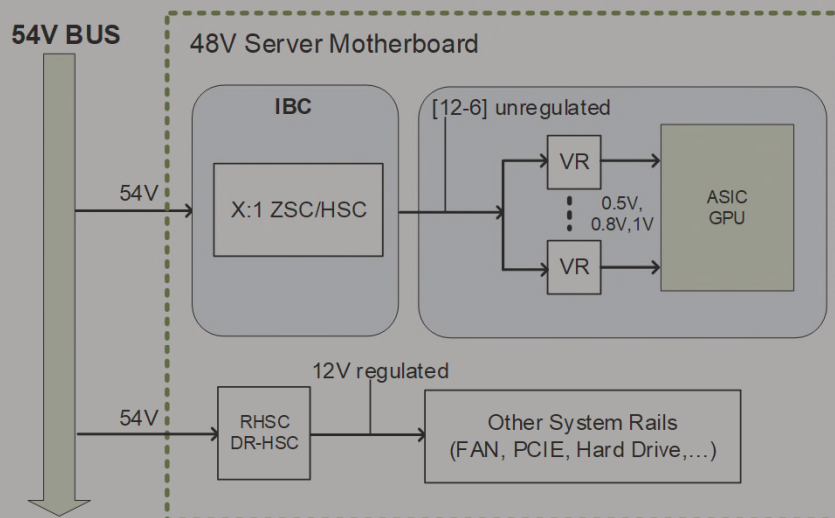
1	48V to Pol application landscape	3
2	ZSC converter overview	5
3	HSC converter	9
4	Summary	19

Table of contents

1	48V to Pol application landscape	3
2	ZSC converter overview	5
3	HSC converter	9
4	Summary	19

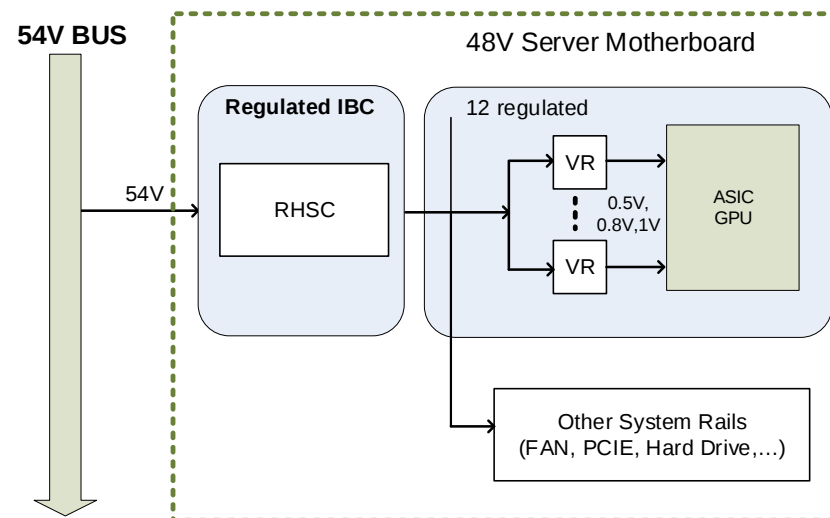
48 V to PoL application landscape

Unregulated IBC approach



- Most of the solution are not processing energy through physical inductor
- ZVS and/or ZCS can be easily achieved
- Suffers at low input voltage

Regulated IBC approach



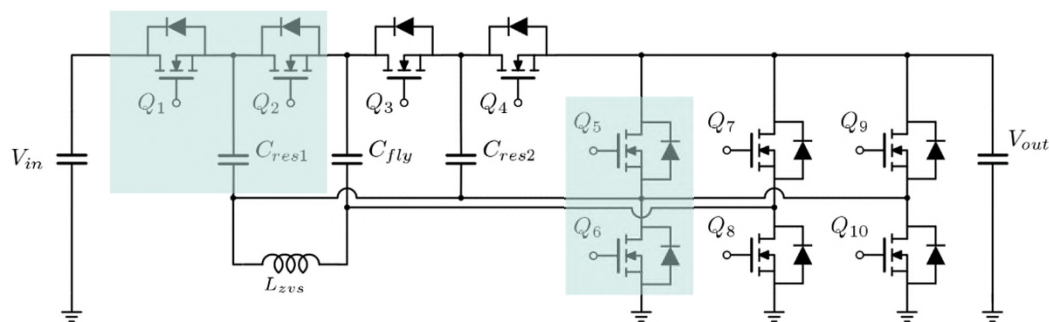
- Required all/part of the energy to be processed by inductor
- Soft switching difficult to achieved (DC current component)
- Suffers at high input voltage

Table of contents

1	48V to Pol application landscape	3
2	ZSC converter overview	5
3	HSC converter	9
4	Summary	19

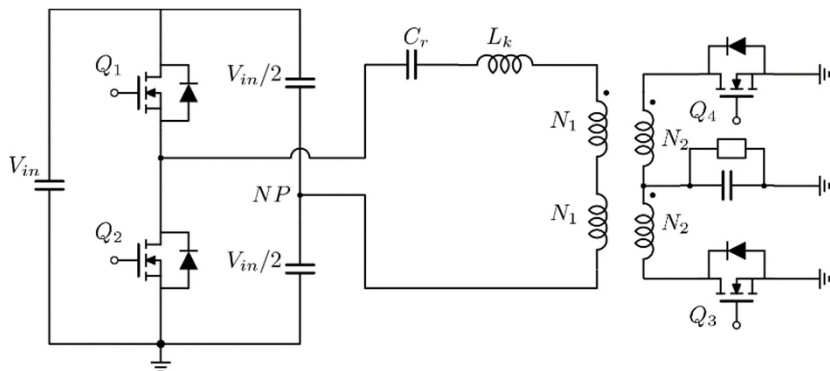
From Switched Capacitor to Hybrid Switched capacitor converters

Zero-Voltage switching switched capacitor converter

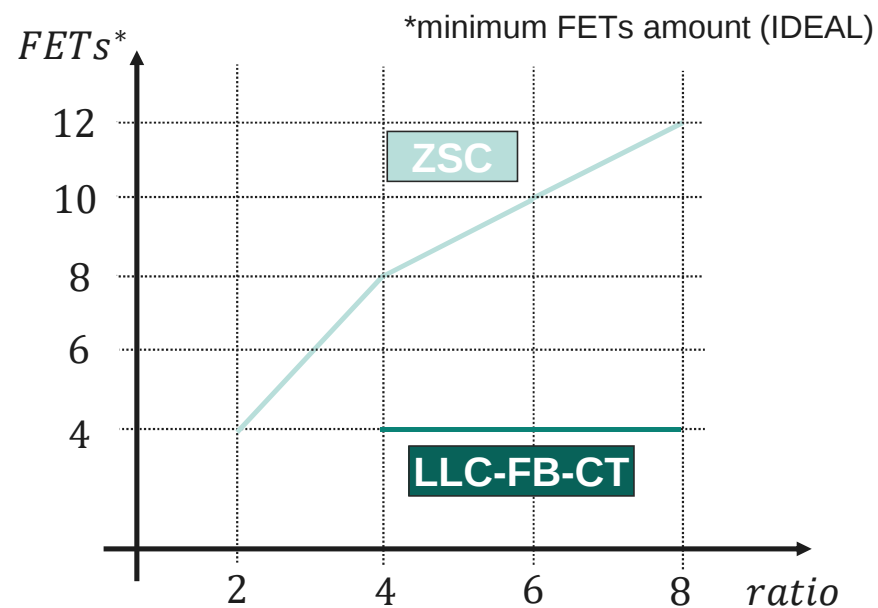


> SC based topology, ratio given from SC cells

LLC HB-CT

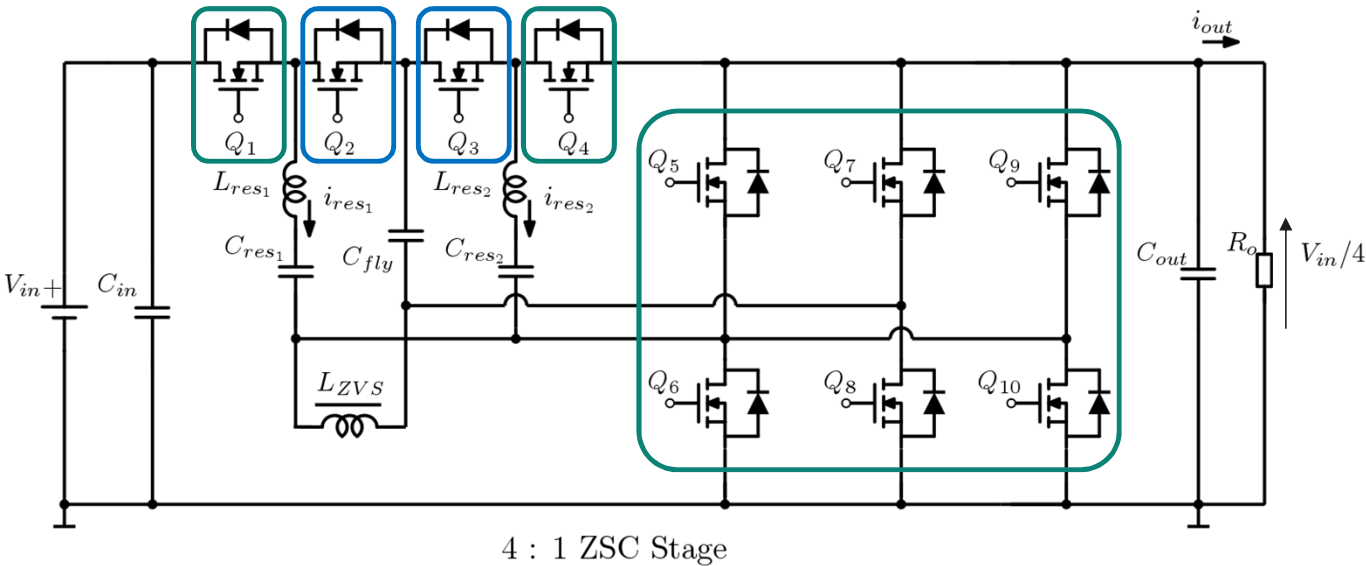


Transformer based topology, ratio given by transformer ratio



Hybrid Switched capacitor is combining SC cells with magnetic device

Zero-voltage-switching Switched Capacitor (ZSC) Converter



$\phi_a \dots Q_1, Q_3, Q_5, Q_8, Q_9$

$\phi_\beta \dots Q_2, Q_4, Q_6, Q_7, Q_{10}$

If $V_{in} = 40\text{ V} - 60\text{ V}$:

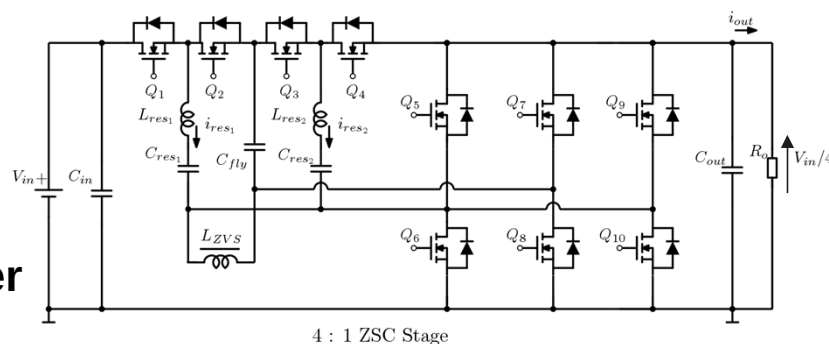
- 25 V MOSFET
- 40 V MOSFET

Zero-voltage-switching Switched Capacitor (ZSC) Converter

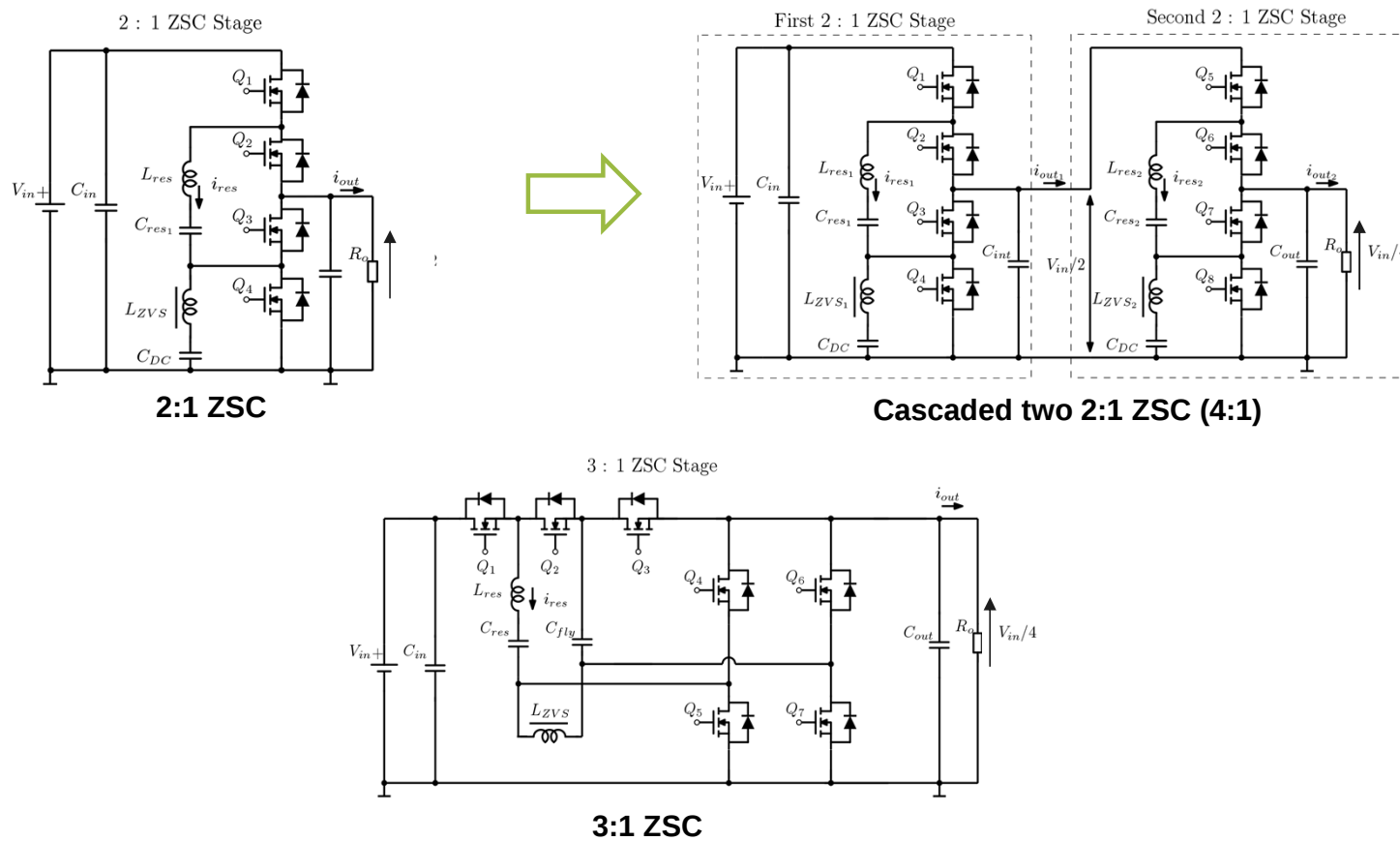


Technical Features

- Very **high efficiency** and **density** reachable
- Low voltage FETs with **better FOM** (V_{out} , $2 \times V_{out}$)
- **Soft-switching** operation regardless of tolerance of components and input voltage variation (L_{ZVS} provides soft-switching capability)
- No power magnetic components in the main current path
→ **high power capability**
- **High switching frequency** operation possible due to ZVS switching
- Inherent **droop current sharing** for parallel operation

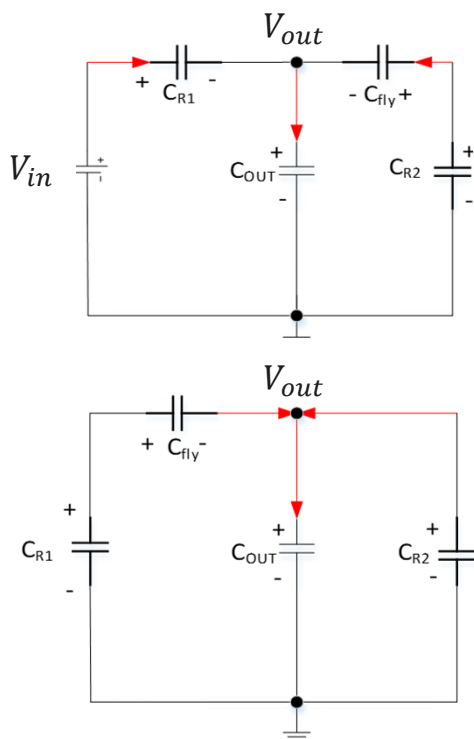


ZSC Implementation Flexibility



Calculation of Voltage Conversion Ratio in Steady-State

The average voltage of each capacitor can be calculated by combining the equivalent circuit in charging and discharging modes.



Charging Mode

$$\begin{aligned} V_{in} &= V_{CR1} + V_{out} \\ V_{CR2} &= V_{out} + V_{Cfly} \end{aligned}$$

Discharging Mode

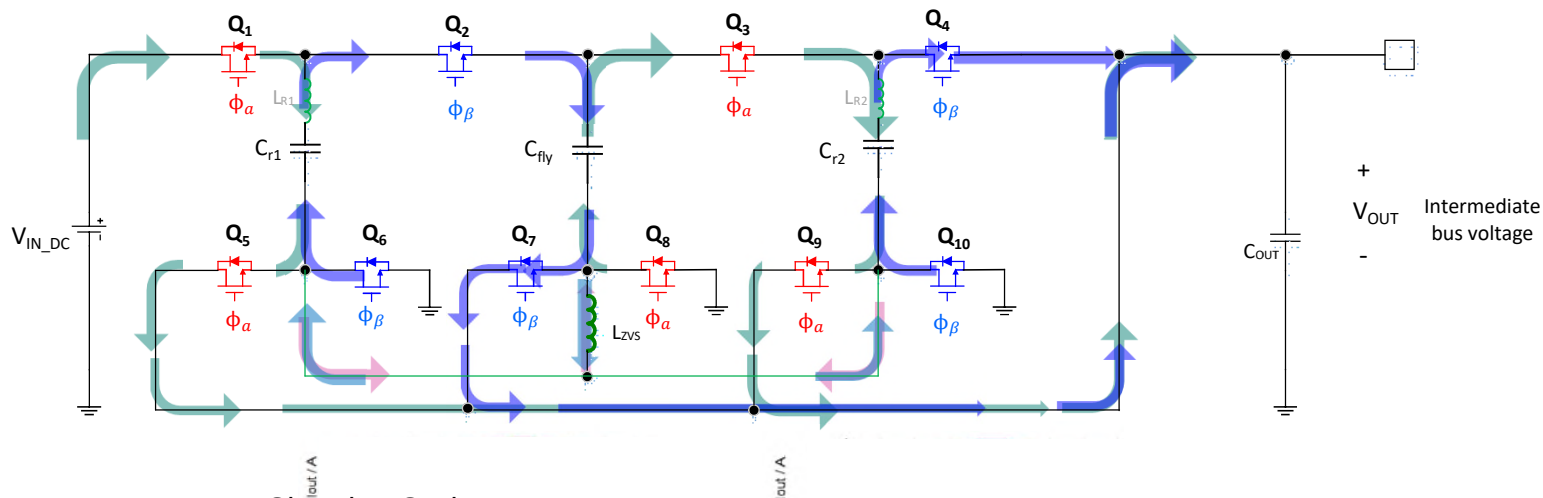
$$\begin{aligned} V_{CR1} &= V_{Cfly} + V_{out} \\ V_{CR2} &= V_{out} \end{aligned}$$

$$\begin{aligned} V_{CR2} &= V_{out} \\ V_{fly} &= 2 V_{out} \\ V_{CR1} &= 3 V_{out} \\ V_{in} &= 4 V_{out} \end{aligned}$$

↓

$$V_{out} = \frac{1}{4} V_{in}$$

ZSC Topology in Action

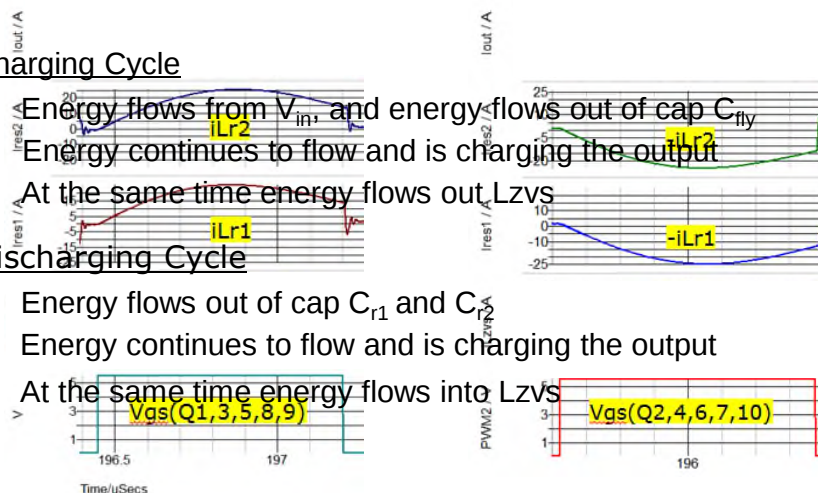


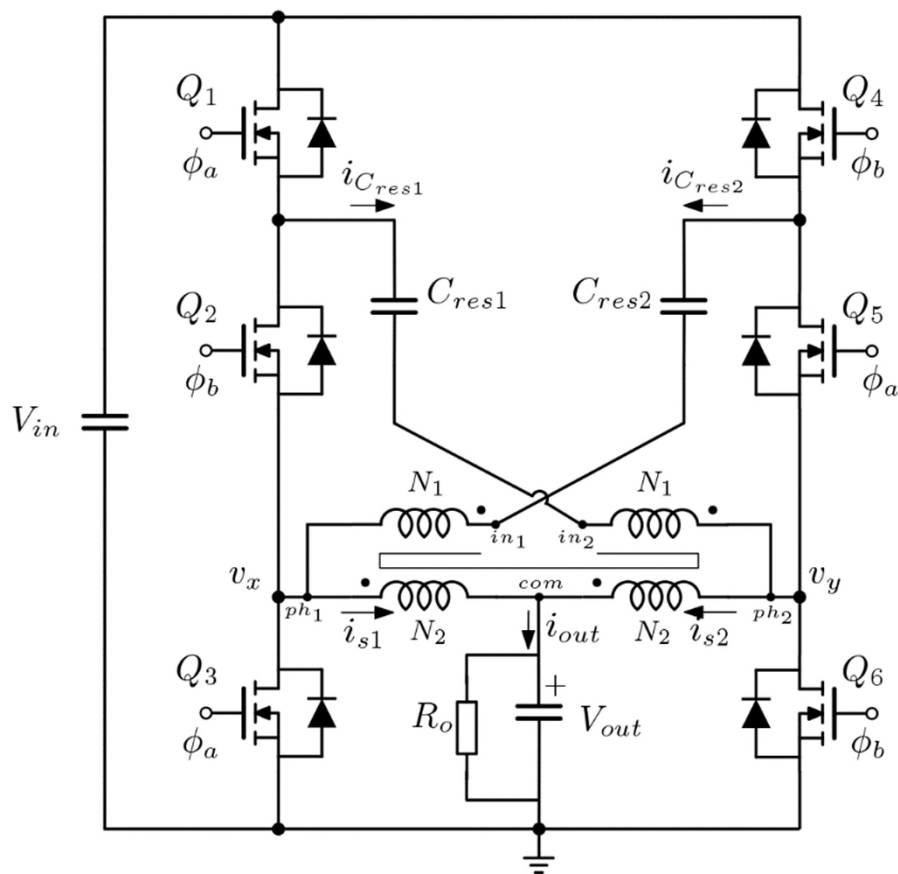
Charging Cycle

- > Energy flows from V_{in} and energy flows out of cap C_{fly}
- > Energy continues to flow and is charging the output
- > At the same time energy flows into L_{zvs}

Discharging Cycle

- > Energy flows out of cap C_{r1} and C_{r2}
- > Energy continues to flow and is charging the output
- > At the same time energy flows into L_{zvs}



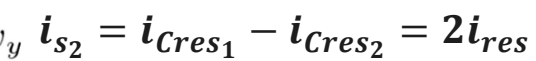


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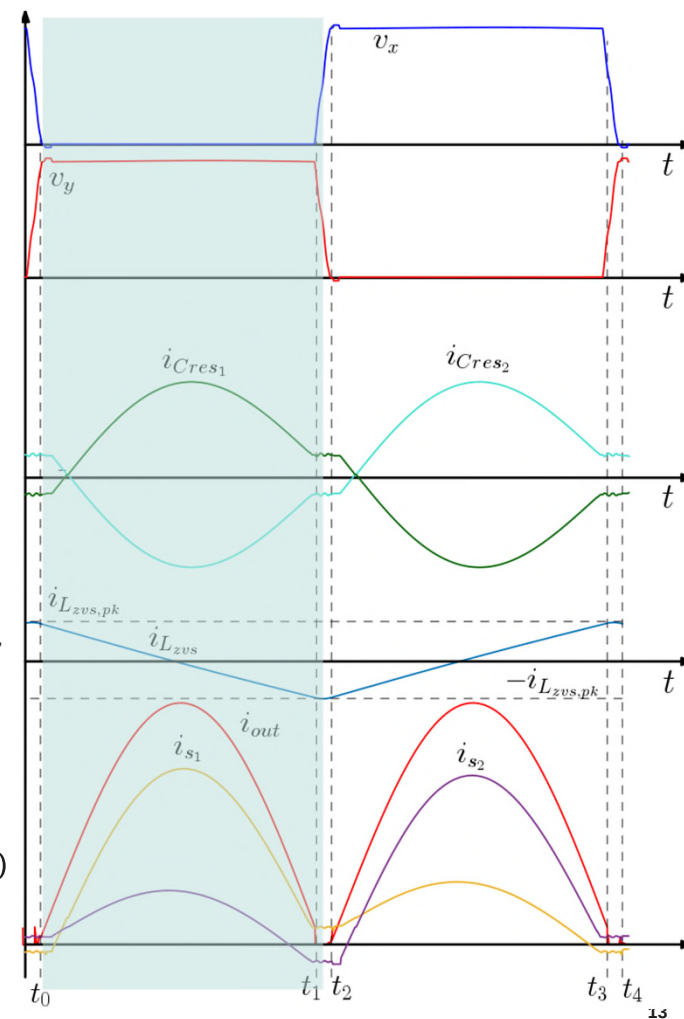
public

- **Different ratios** are possible maintaining the same number of FETs 5:1 6:1 8:1 as optimized conversion ratio.
- **Soft-switching** operation regardless tolerance components and input voltage variation (L_m of the **Multi-Tapped Autotransformer** provides soft-switching capability)
- L_k of the **Multi-Tapped Autotransformer** ensure **soft-charging** of the C_{res1} , C_{res2} and C_{out}
- **Simplified driving system** (no need charge pump)
- **Symmetric operation** (less input current ripple)
- Q_2 and Q_5 have to block V_{in} in their off state
- Q_1 and Q_4 have to block $\frac{V_{in}}{2} + V_{out} \frac{N_1}{N_2}$
- Q_3 and Q_6 have to block $2V_{out}$ voltage in their off state

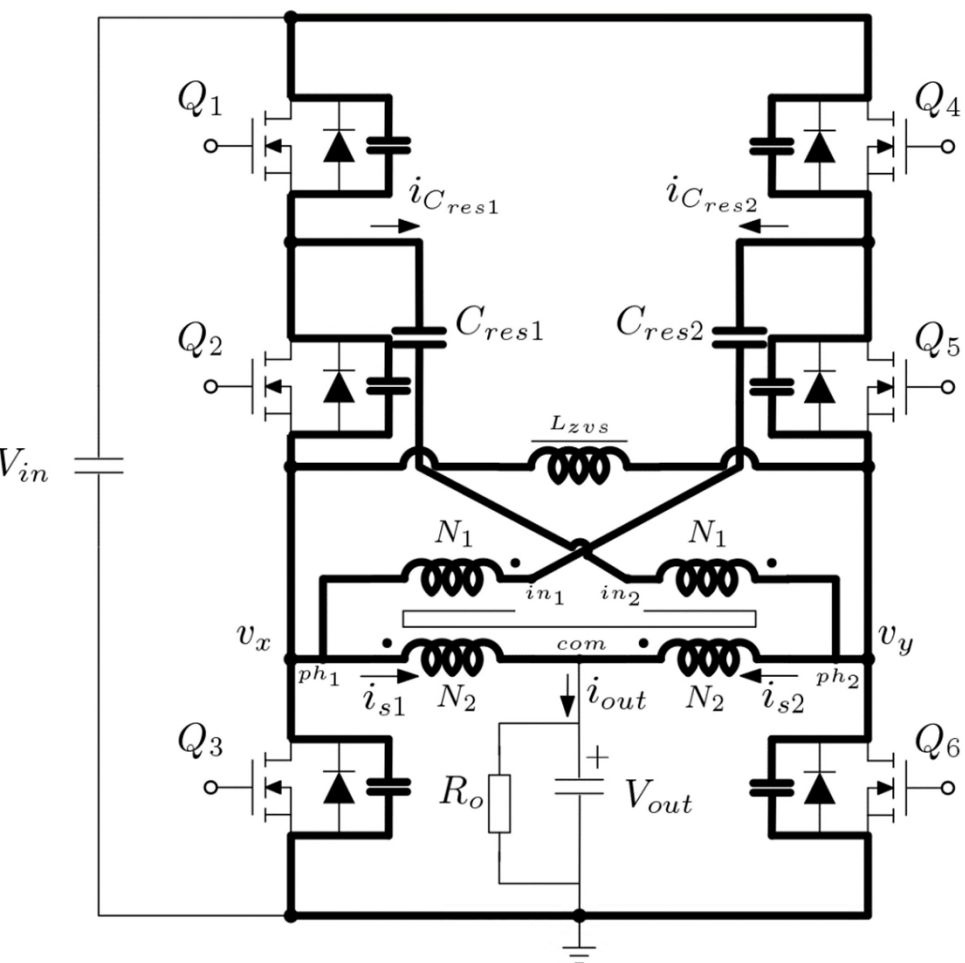
$$V_{out} = \frac{V_{in}}{4 + 2 \frac{N_1}{N_2}}$$



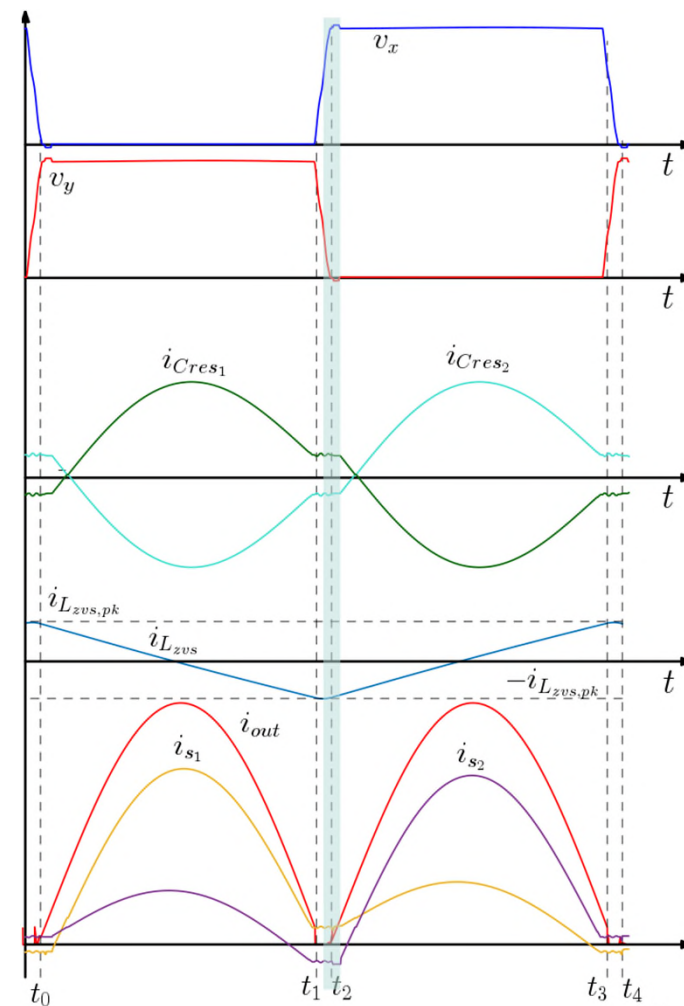
$$i_{s_1} = \left(\frac{N_1}{N_2} + 1\right) i_{s_2} = \left(\frac{N_1}{N_2} + 1\right) (2\mathbf{i}_{res})$$



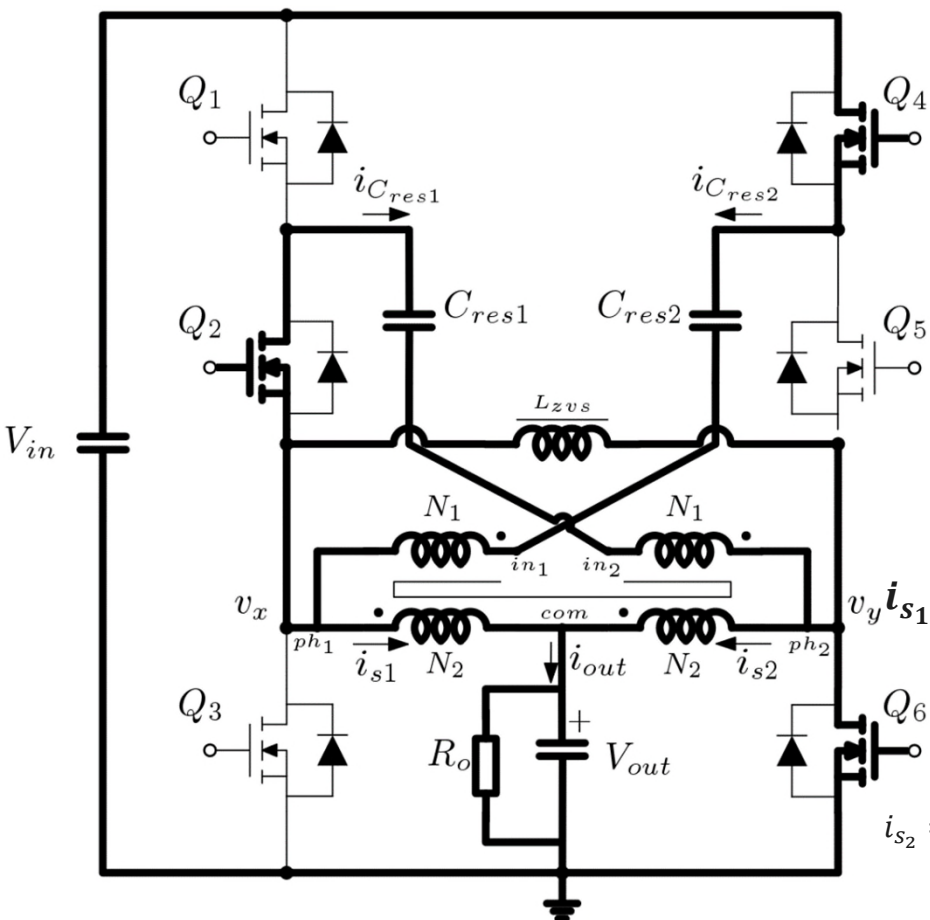
Dead time



• Symmetric ZVS operation for all FETs

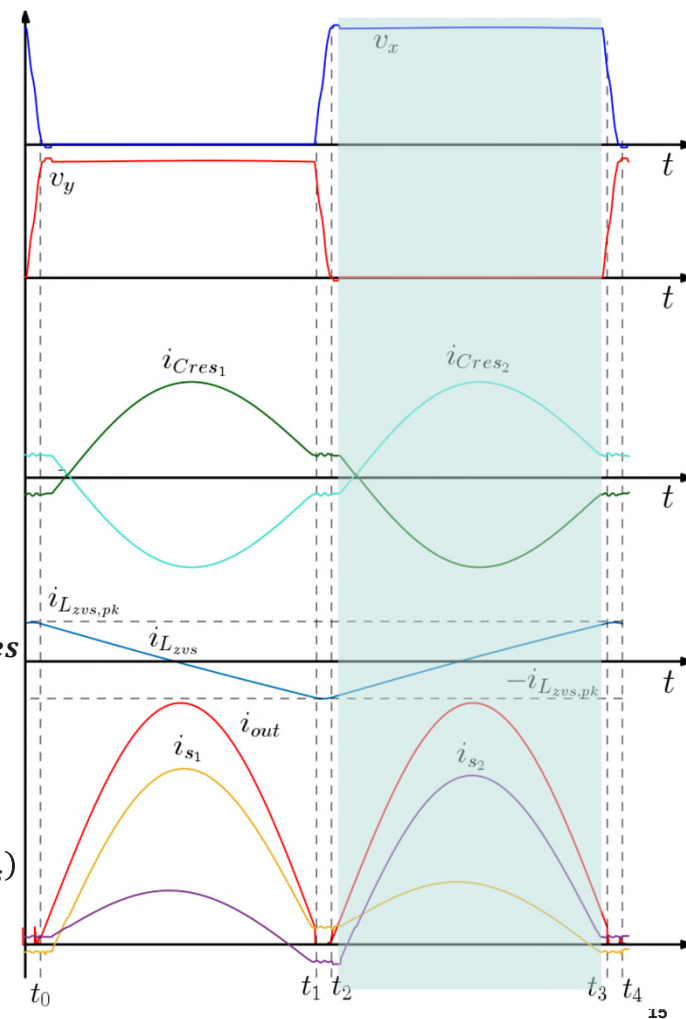


Phase Φ_B



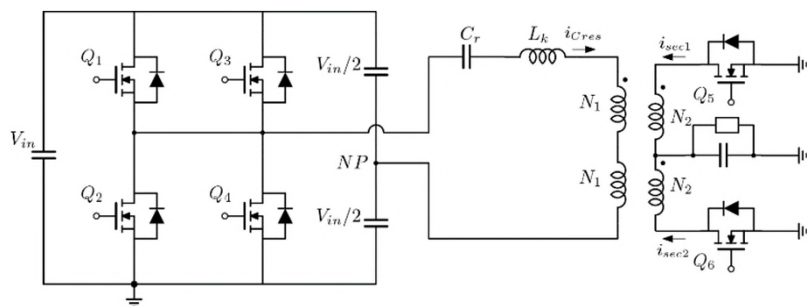
$$v_y i_{s1} = -i_{Cres1} + i_{Cres2} = 2i_{res}$$

$$i_{s2} = \left(\frac{N_1}{N_2} + 1\right) i_{s1} = \left(\frac{N_1}{N_2} + 1\right) (2i_{res})$$

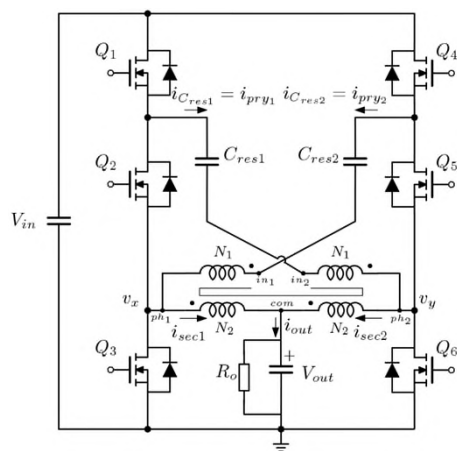


Comparison HSC with LLC-HB-CT converter

LLC HB-CT



Hybrid Switched capacitor



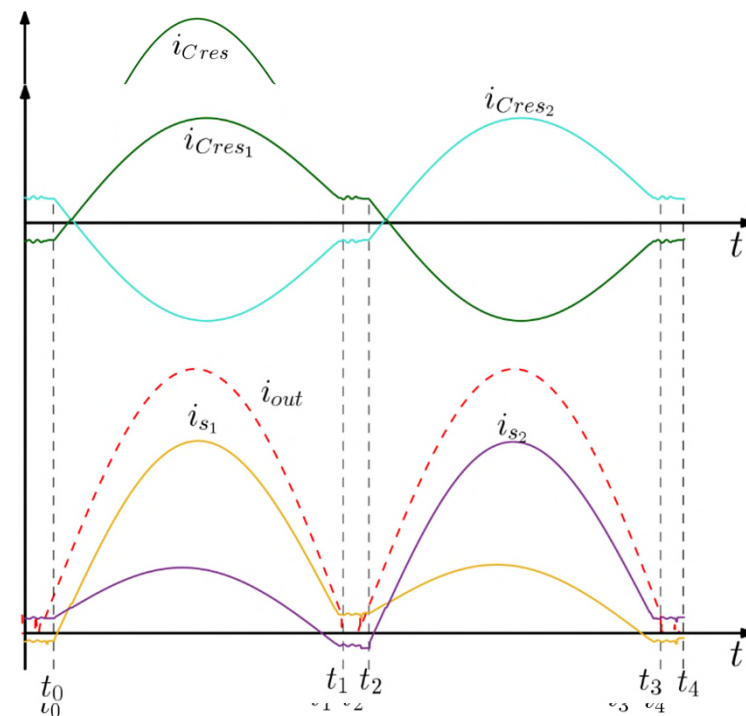
Both converter running at the **resonant frequency** $f_{sw} \simeq f_{res}$

High Q factor -> **ZCS**

Comparison with the same amount of FETs

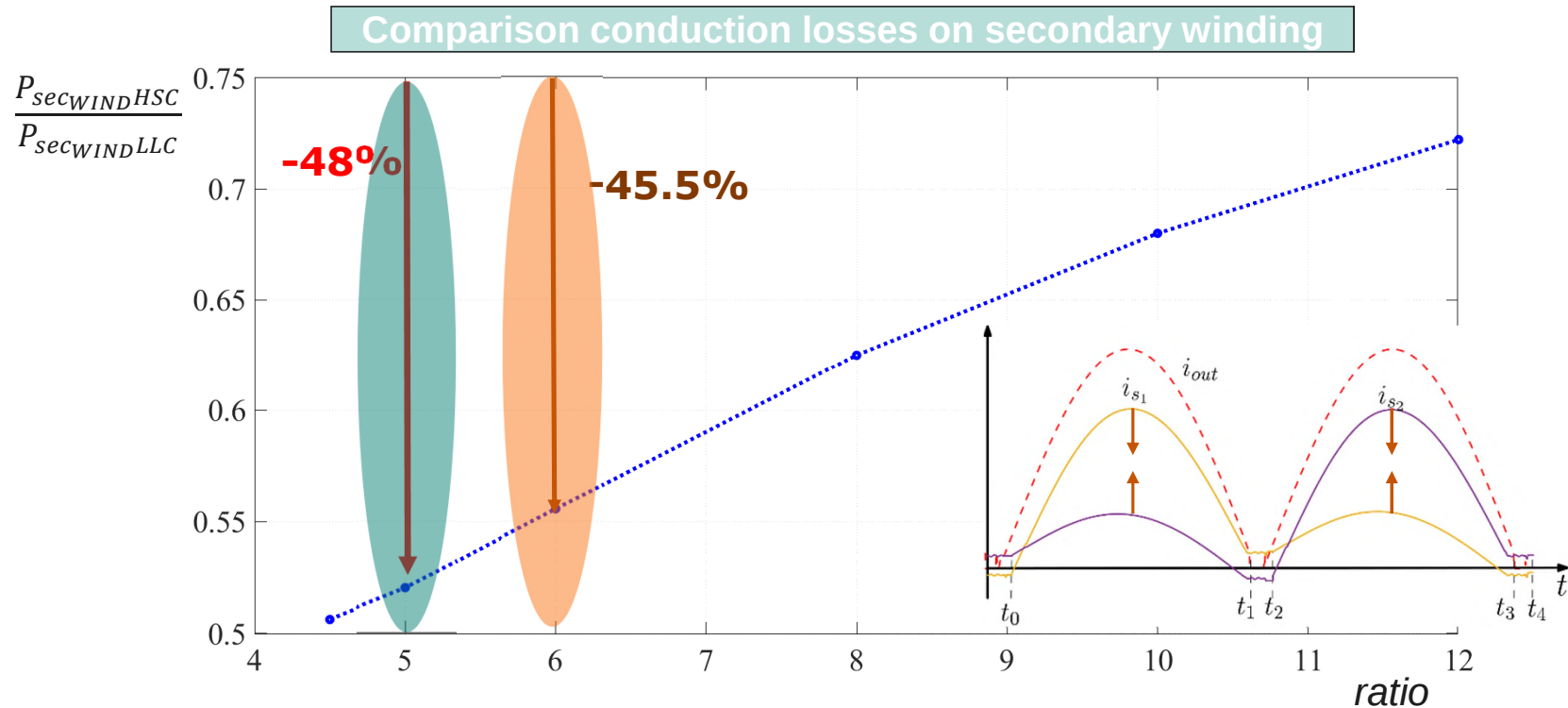
ZVS ensures by the **magnetizing inductance** in **HSC** and **LLC**

Hybrid Switched capacitor waveforms



Theoretical comparison between LLC and HSC

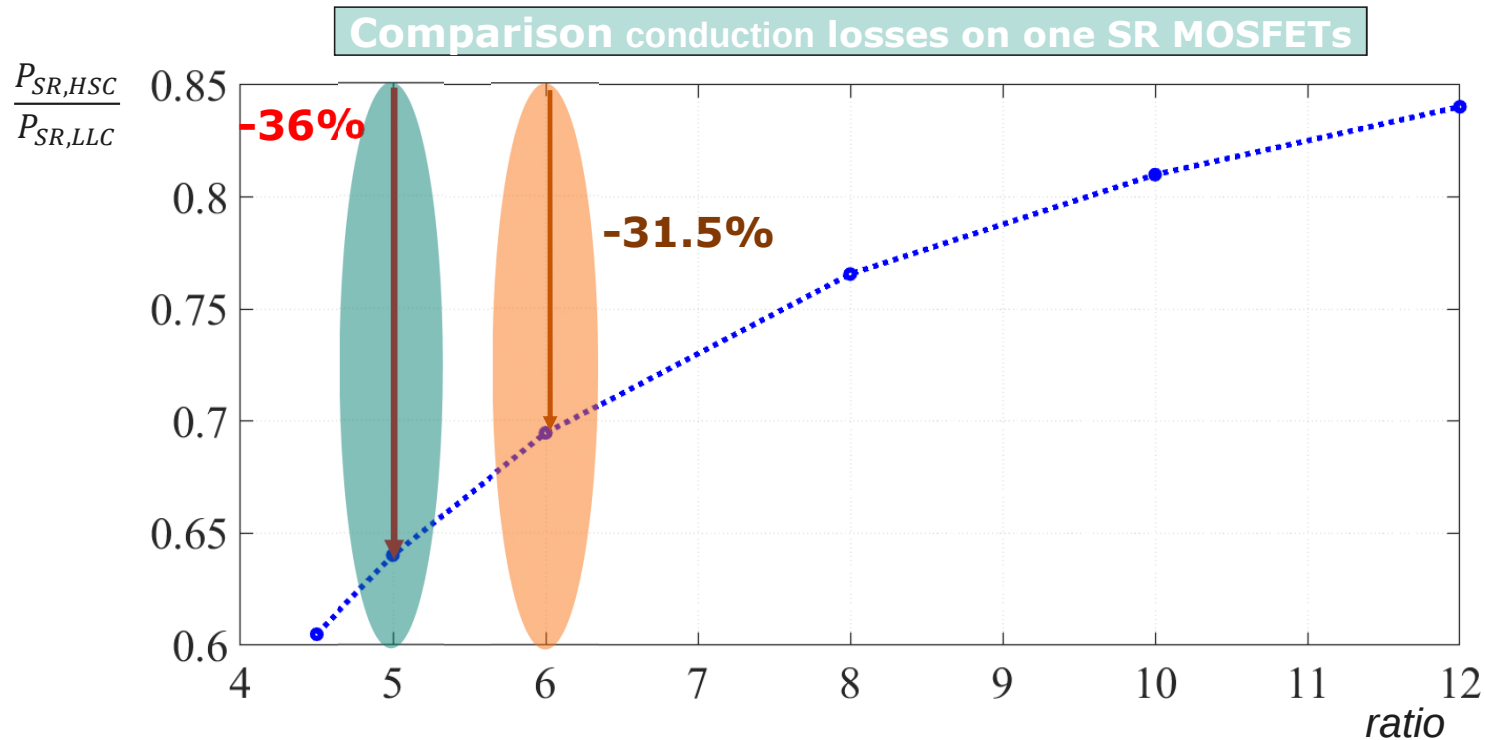
Secondary windings losses



In **5:1 HSC**, considering $R_{secHSC} = R_{secLLC}$, the **conduction losses** on secondary windings are **reduced by 48%**.

Theoretical comparison between LLC and HSC

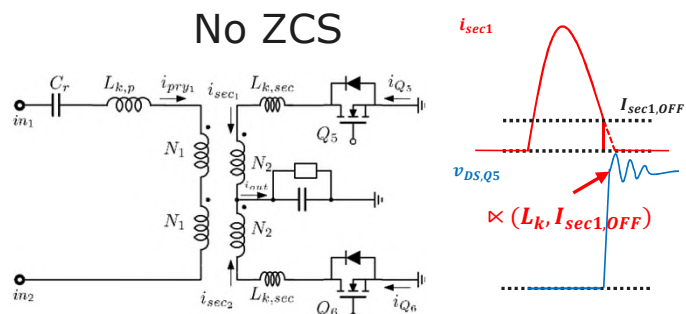
SR MOS losses



In **5:1 HSC**, considering $R_{on,SR_{HSC}} = R_{on,SR_{LLC}}$, the **conduction losses** on SR FETs are **reduced** by **36%**.

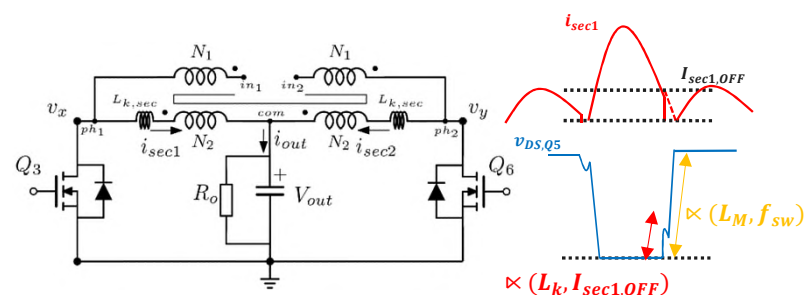
Robustness of HSC comparing with LLC

LLC



- › If LLC is not in **ZCS** there are **additional losses** proportional with the leakage inductance of secondary windings and the turn-off secondary current

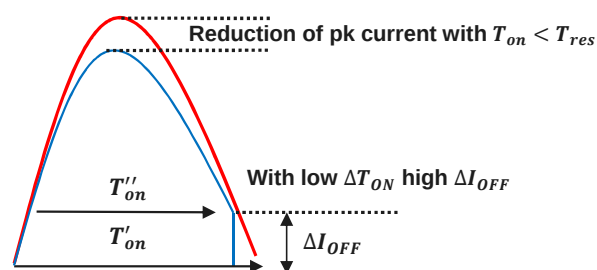
HSC



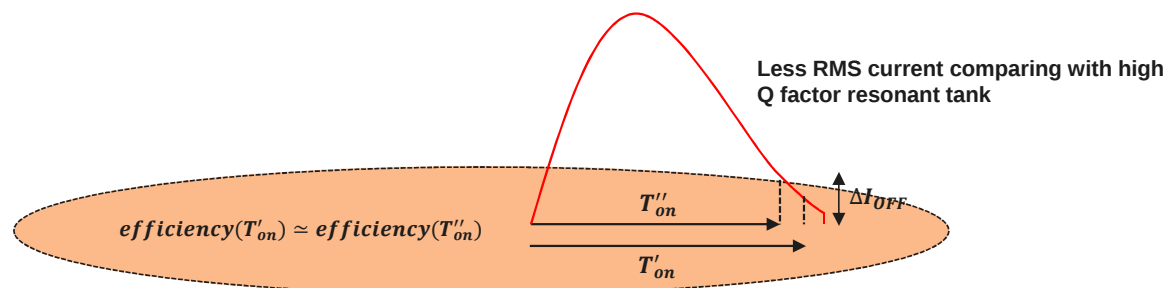
- › If HSC is not in **ZCS** there is **not anymore** a dependence with the turn off current in terms of **losses** because of **ZVS** operation in all FETs.

Resonant tank Q factor

With **high Q** factor resonant tank



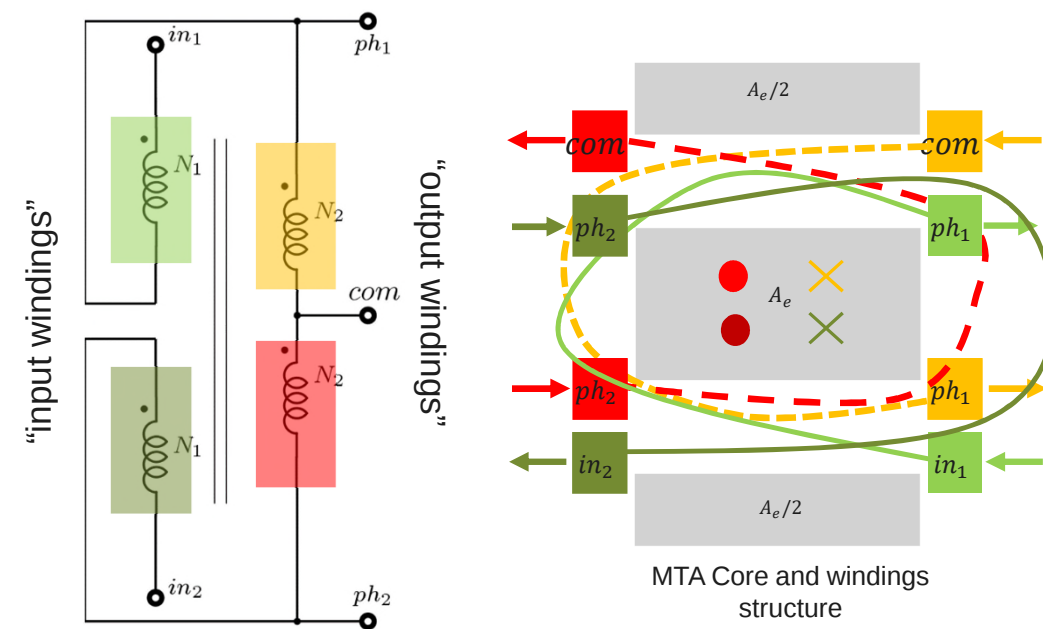
With **low Q** factor resonant tank



HSC magnetic can guarantee low leakage inductance, so as low energy impacting ZVS performance and chance to run over resonant frequency improving efficiency and reliability in mass production

Multi-tapped autotransformer

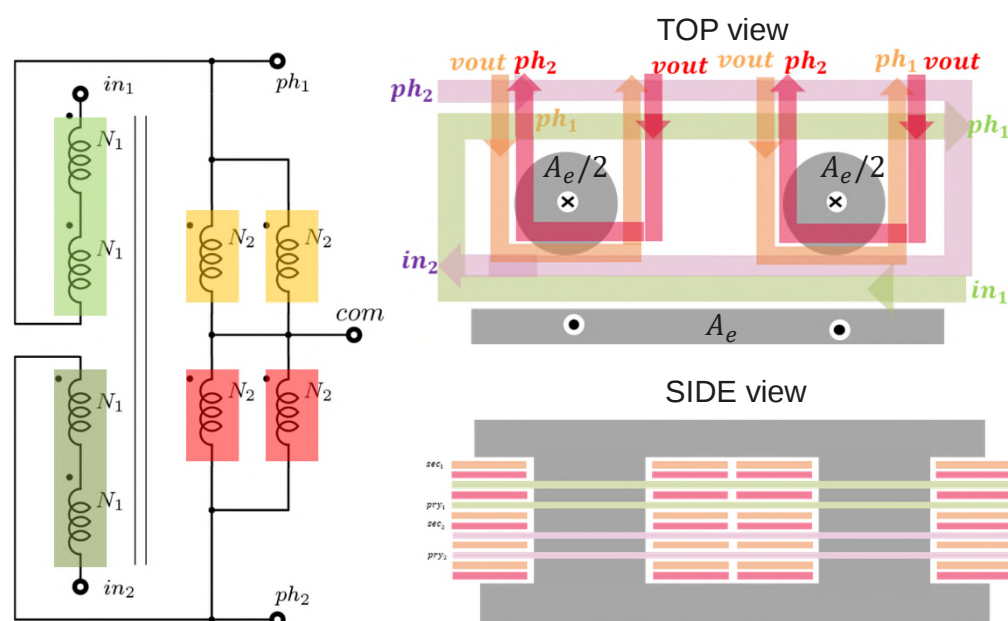
Multi-tapped



MTA

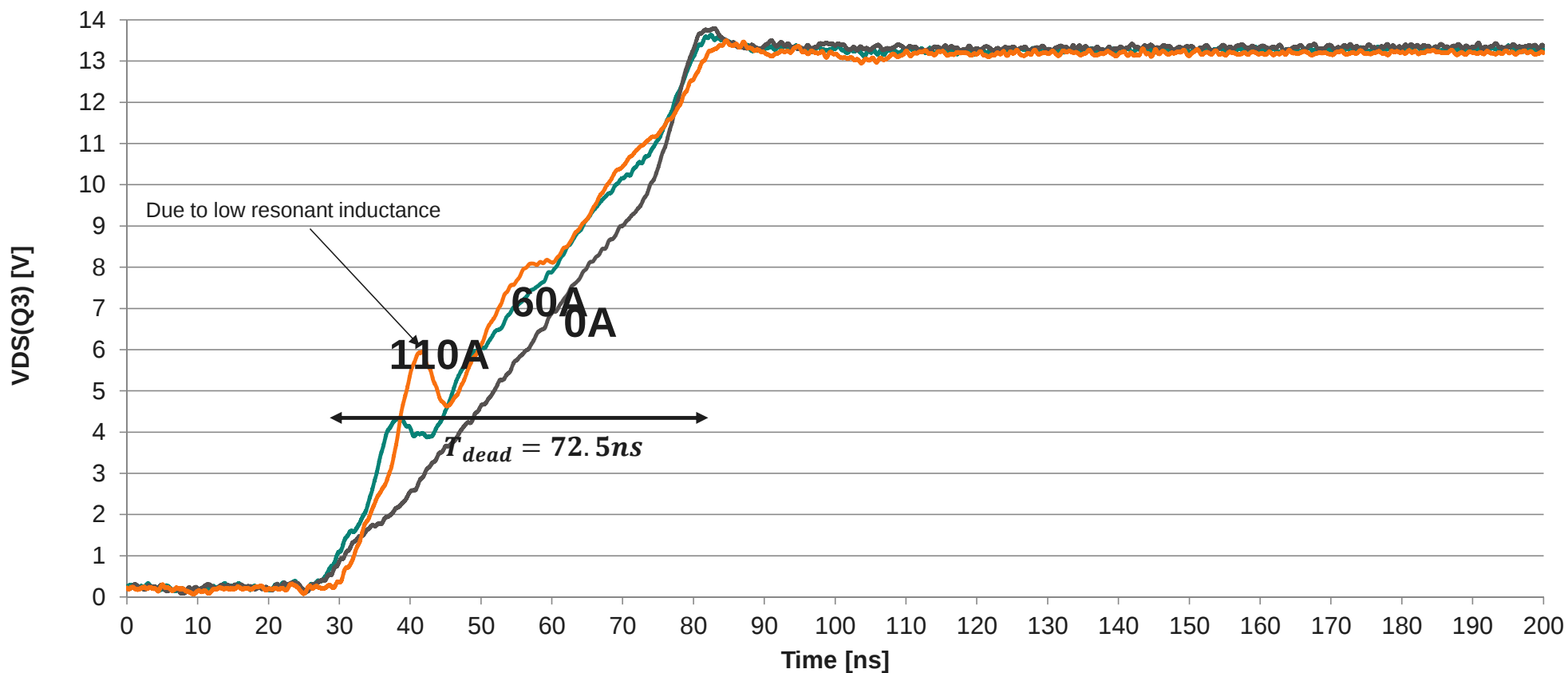
- Core volume optimization
- Optimal for <500W 8:1 IBC

Matrix Multi-tapped



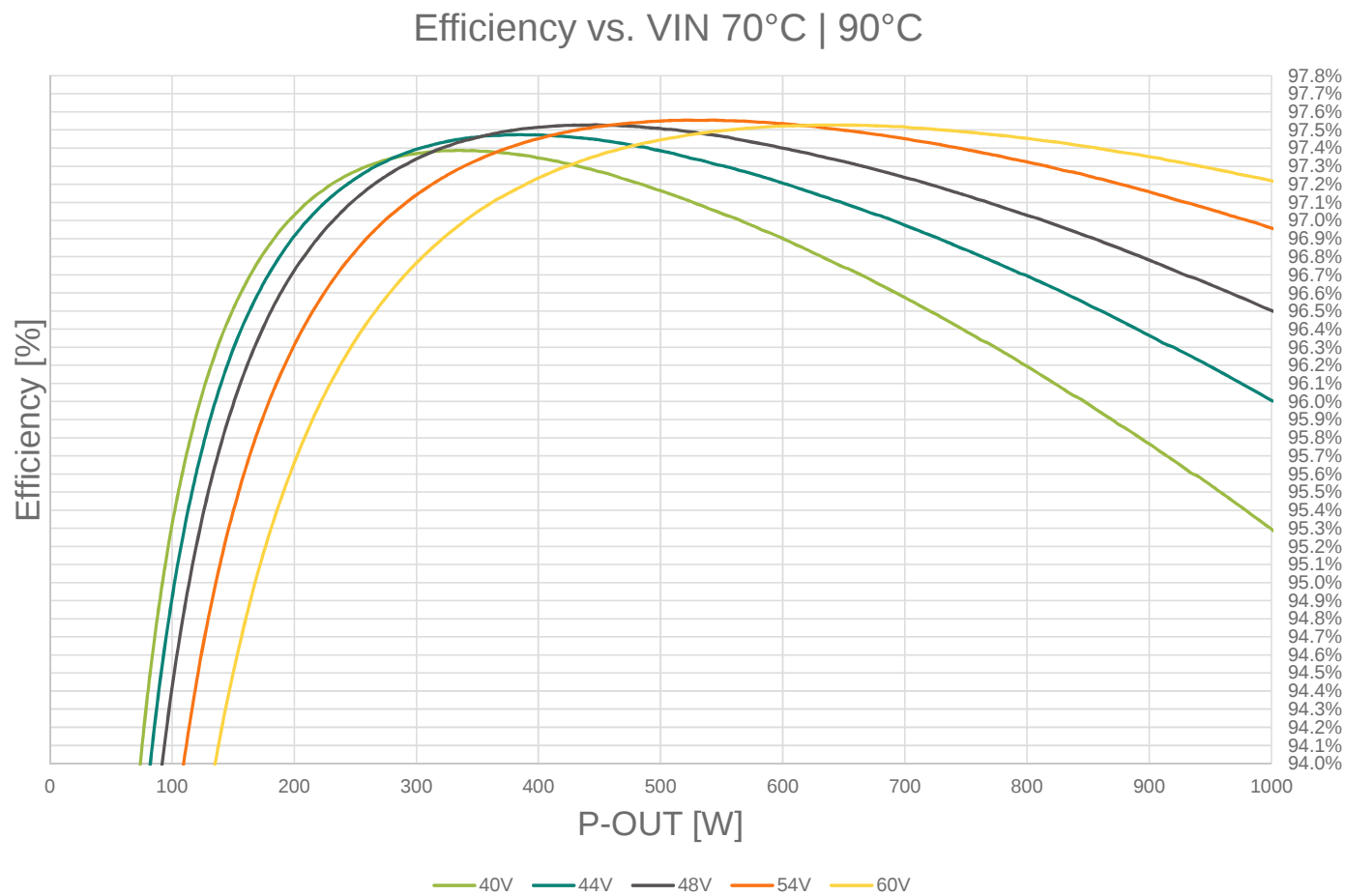
- Conduction losses optimization
- Optimal for >500W 8:1 IBC

ZVS behaviour over load – Experimental waveforms



- HSC can run above resonant frequency (to reduce RMS current) without compromise ZVS capability when low Q factor can be implemented (i.e. in a module solution)

Measured HSC efficiency in challenging thermal environment





Abstract:

The requirements for power systems that support high-performance AI computing infrastructure with 40 V to 60 V inputs are becoming increasingly challenging. Higher efficiency and power-density requirements are changing rapidly, and the thermal environment is becoming more difficult to manage. To manage PDN losses, power must be delivered closer to the point of load, and intermediate bus voltages require flexibility to achieve the best overall efficiency and transient response. Chris R. Swartz will discuss how adding a multi-tapped autotransformer to the super-efficient ZVS switched-capacitor topology creates the Hybrid Switched-Capacitor (HSC) topology and enables additional flexibility in conversion ratios without increasing the number of cells or the number of power switches. The benefits of the HSC topology as a means of providing over 1 kW of intermediate power, with transient capability of $2\times$ TDP and high conversion efficiency in thermally challenging environments, will be discussed. Additional system benefits — such as a novel startup scheme, simple droop current sharing, and the ability to synchronize multiple stages — will be shown.

Seminar Presenter:



Chris R. Swartz is a Senior Member of the IEEE with more than 36 years of experience in power electronics design. He began his career at Motorola Inc., where he worked on both digital and power electronics during a ten-year tenure there. Chris then spent 14 years at Emerson Network Power (formerly Artesyn Technologies), designing both fully custom and standard AC–DC and DC–DC products. Chris subsequently worked for two years at Transim Technology, focusing on advanced power electronics and thermal simulation, before embarking on a 16-year career with Vicor Corporation as a Senior Principal Engineer. Last February, Chris joined Infineon as a Lead Principal Engineer, what he calls his most exciting role yet!